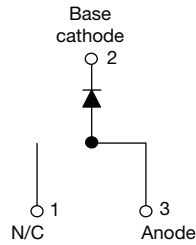


High Performance Schottky Rectifier, 10 A


D²PAK


FEATURES

- 175 °C T_J operation
- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE

| PRODUCT SUMMARY | |
|----------------------------------|--------------------|
| Package | D ² PAK |
| I _{F(AV)} | 10 A |
| V _R | 35 V, 40 V, 45 V |
| V _F at I _F | 0.57 V |
| I _{RM} | 15 mA at 125 °C |
| T _J max. | 175 °C |
| Diode variation | Single die |
| E _{AS} | 13 mJ |

DESCRIPTION

The VS-10TQ...SPbF Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

| MAJOR RATINGS AND CHARACTERISTICS | | | |
|-----------------------------------|--|-------------|-------|
| SYMBOL | CHARACTERISTICS | VALUES | UNITS |
| I _{F(AV)} | Rectangular waveform | 10 | A |
| V _{RRM} | | 35/45 | V |
| I _{FSM} | t _p = 5 μs sine | 1050 | A |
| V _F | 10 A _{pk} , T _J = 125 °C | 0.49 | V |
| T _J | Range | -55 to +175 | °C |

| VOLTAGE RATINGS | | | | |
|--------------------------------------|------------------|----------------|----------------|-------|
| PARAMETER | SYMBOL | VS-10TQ035SPbF | VS-10TQ045SPbF | UNITS |
| Maximum DC reverse voltage | V _R | 35 | 45 | V |
| Maximum working peak reverse voltage | V _{RWM} | | | |

| ABSOLUTE MAXIMUM RATINGS | | | | | |
|--|--------------------|--|--|--------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum average forward current See fig. 5 | I _{F(AV)} | 50 % duty cycle at T _C = 151 °C, rectangular waveform | | 10 | A |
| Maximum peak one cycle non-repetitive surge current See fig. 7 | I _{FSM} | 5 μs sine or 3 μs rect. pulse | Following any rated load condition and with rated V _{RRM} applied | 1050 | A |
| | | 10 ms sine or 6 ms rect. pulse | | 280 | |
| Non-repetitive avalanche energy | E _{AS} | T _J = 25 °C, I _{AS} = 2 A, L = 6.5 mH | | 13 | mJ |
| Repetitive avalanche current | I _{AR} | Current decaying linearly to zero in 1 μs Frequency limited by T _J maximum V _A = 1.5 x V _R typical | | 2 | A |



| ELECTRICAL SPECIFICATIONS | | | | | |
|---|----------------|---|-----------------------------------|--------|------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum forward voltage drop See fig. 1 | $V_{FM}^{(1)}$ | 10 A | $T_J = 25\text{ }^\circ\text{C}$ | 0.57 | V |
| | | 20 A | | 0.67 | |
| | | 10 A | $T_J = 125\text{ }^\circ\text{C}$ | 0.49 | |
| | | 20 A | | 0.61 | |
| Maximum reverse leakage current See fig. 2 | $I_{RM}^{(1)}$ | $T_J = 25\text{ }^\circ\text{C}$ | $V_R = \text{Rated } V_R$ | 2 | mA |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 15 | |
| Maximum junction capacitance | C_T | $V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), $25\text{ }^\circ\text{C}$ | | 900 | pF |
| Typical series inductance | L_S | Measured lead to lead 5 mm from package body | | 8.0 | nH |
| Maximum voltage rate of change | dV/dt | Rated V_R | | 10 000 | V/ μs |

Note

(1) Pulse width < 300 μs , duty cycle < 2 %

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | |
|--|----------------|--------------------------------------|--|-------------|------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum junction and storage temperature range | T_J, T_{Stg} | | | -55 to +175 | $^\circ\text{C}$ |
| Maximum thermal resistance, junction to case | R_{thJC} | DC operation See fig. 4 | | 2.0 | $^\circ\text{C/W}$ |
| Typical thermal resistance, case to heatsink | R_{thCS} | Mounting surface, smooth and greased | | 0.50 | |
| Approximate weight | | | | 2 | g |
| | | | | 0.07 | oz. |
| Mounting torque | minimum | | | 6 (5) | kgf · cm (lbf · in) |
| | maximum | | | 12 (10) | |
| Marking device | | Case style D ² PAK | | 10TQ045S | |

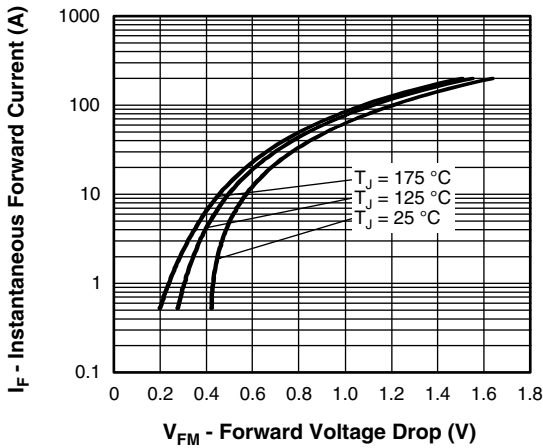


Fig. 1 - Maximum Forward Voltage Drop Characteristics

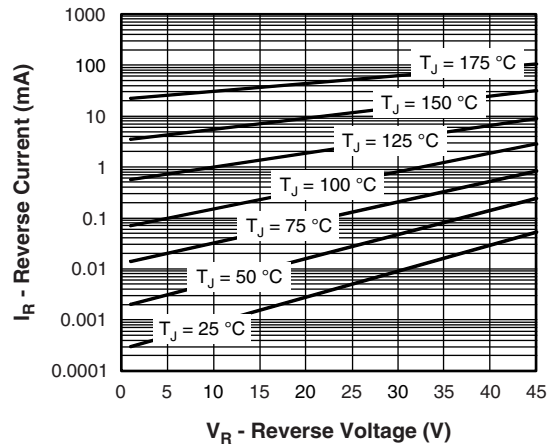


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

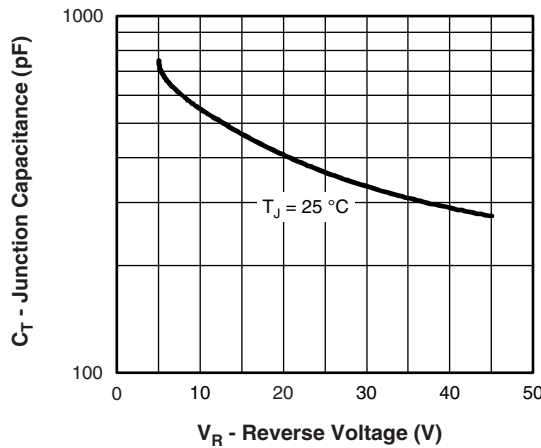


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

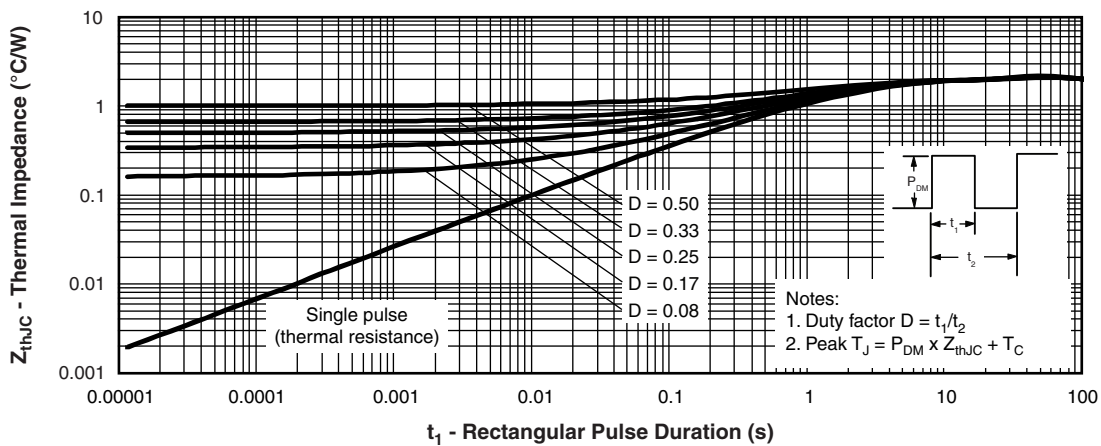


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

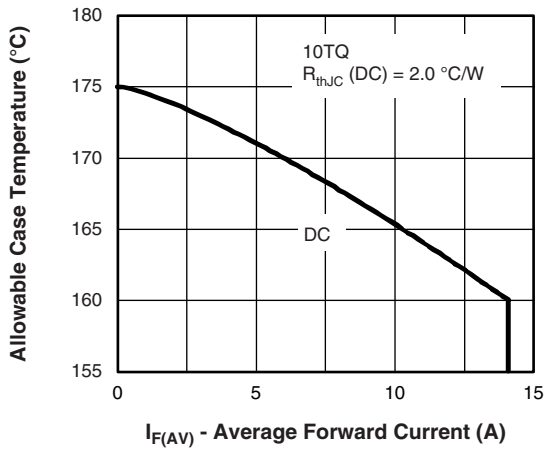


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

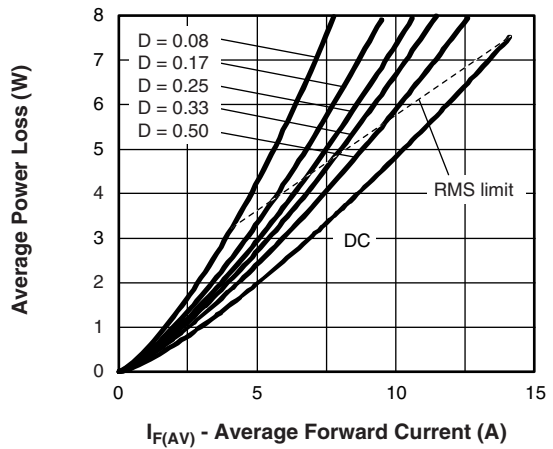


Fig. 6 - Forward Power Loss Characteristics

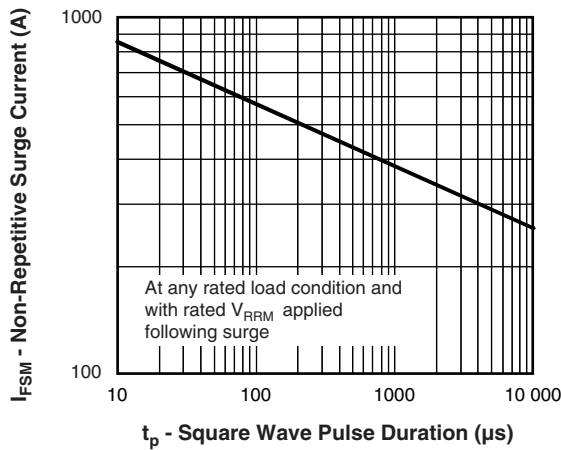


Fig. 7 - Maximum Non-Repetitive Surge Current

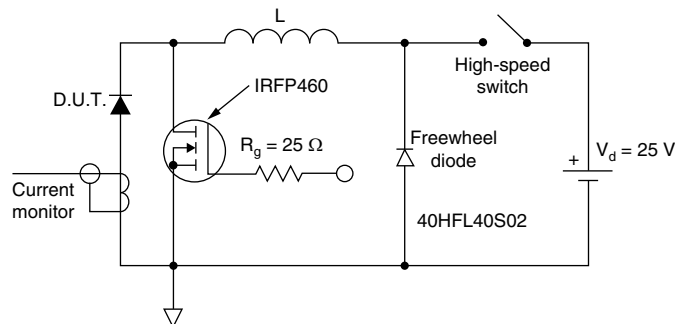
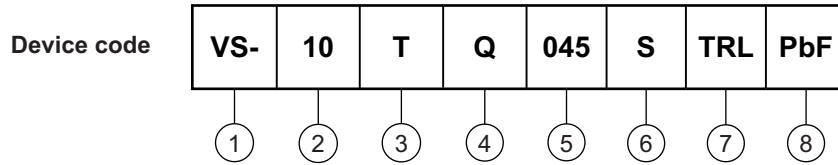


Fig. 8 - Unclamped Inductive Test Circuit



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Current rating (10 A)
- 3** - Circuit configuration: T = D²PAK
- 4** - Schottky "Q" series
- 5** - Voltage ratings —————

| |
|------------|
| 035 = 35 V |
| 045 = 45 V |
- 6** - S = D²PAK
- 7** -
 - None = tube (50 pieces)
 - TRL = tape and reel (left oriented)
 - TRR = tape and reel (right oriented)
- 8** - PbF = lead (Pb)-free

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|--|
| Dimensions | www.vishay.com/doc?95014 |
| Part marking information | www.vishay.com/doc?95008 |
| Packaging information | www.vishay.com/doc?95032 |

D²PAK, TO-262

DIMENSIONS FOR D²PAK in millimeters and inches

Conforms to JEDEC outline D²PAK (SMD-220)



| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|--------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | 4.06 | 4.83 | 0.160 | 0.190 | |
| A1 | 0.00 | 0.254 | 0.000 | 0.010 | |
| b | 0.51 | 0.99 | 0.020 | 0.039 | |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 | 4 |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 |
| c | 0.38 | 0.74 | 0.015 | 0.029 | |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 | 4 |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 | |
| D | 8.51 | 9.65 | 0.335 | 0.380 | 2 |

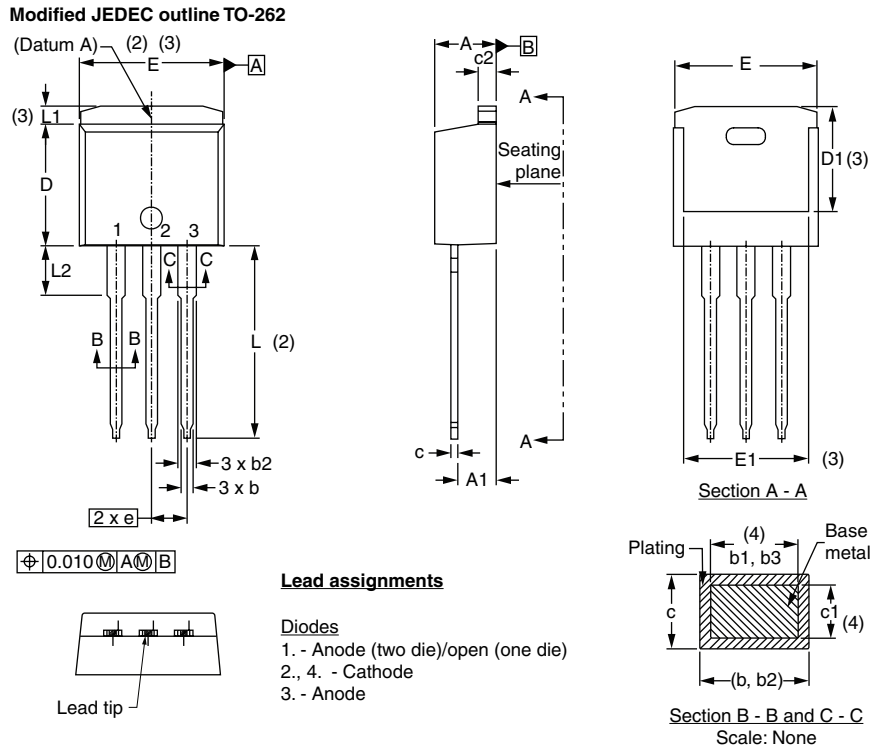
| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|-----------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| D1 | 6.86 | 8.00 | 0.270 | 0.315 | 3 |
| E | 9.65 | 10.67 | 0.380 | 0.420 | 2, 3 |
| E1 | 7.90 | 8.80 | 0.311 | 0.346 | 3 |
| e | 2.54 BSC | | 0.100 BSC | | |
| H | 14.61 | 15.88 | 0.575 | 0.625 | |
| L | 1.78 | 2.79 | 0.070 | 0.110 | |
| L1 | - | 1.65 | - | 0.066 | 3 |
| L2 | 1.27 | 1.78 | 0.050 | 0.070 | |
| L3 | 0.25 BSC | | 0.010 BSC | | |
| L4 | 4.78 | 5.28 | 0.188 | 0.208 | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

- (7) Outline conforms to JEDEC outline TO-263AB

DIMENSIONS FOR TO-262 in millimeters and inches



| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|-----------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | 4.06 | 4.83 | 0.160 | 0.190 | |
| A1 | 2.03 | 3.02 | 0.080 | 0.119 | |
| b | 0.51 | 0.99 | 0.020 | 0.039 | |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 | 4 |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 |
| c | 0.38 | 0.74 | 0.015 | 0.029 | |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 | 4 |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 | |
| D | 8.51 | 9.65 | 0.335 | 0.380 | 2 |
| D1 | 6.86 | 8.00 | 0.270 | 0.315 | 3 |
| E | 9.65 | 10.67 | 0.380 | 0.420 | 2, 3 |
| E1 | 7.90 | 8.80 | 0.311 | 0.346 | 3 |
| e | 2.54 BSC | | 0.100 BSC | | |
| L | 13.46 | 14.10 | 0.530 | 0.555 | |
| L1 | - | 1.65 | - | 0.065 | 3 |
| L2 | 3.56 | 3.71 | 0.140 | 0.146 | |

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline



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Благодаря нацеленности на результат, мы уверенно занимаем новые позиции на рынке, заинтересовывая Клиента не только актуальными ценами и гибким подходом, но и постоянным вниманием.

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- Минимальные сроки поставок;
- Техническая поддержка;
- Подбор комплектации;
- Индивидуальный подход;
- Гибкие цены.

Модули, микросхемы, пассивные компоненты, Xilinx (XC), Altera (EP,EPF, EPM) и силовая электроника – это наши ведущие позиции, на поставку которых мы гарантированно дадим Вам самые выгодные предложения!

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- Подбор оптимального решения при выборе компонента;
- Подбор аналогов;
- Техническая поддержка;
- Консультации у производителей;
- Поставка прототипов;

С Уважением, Чернов Павел.

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